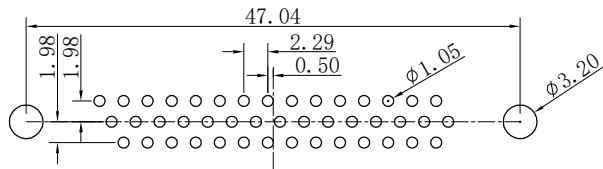
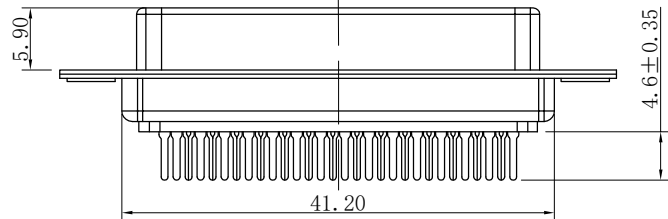
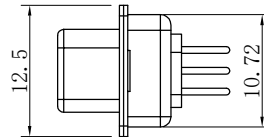
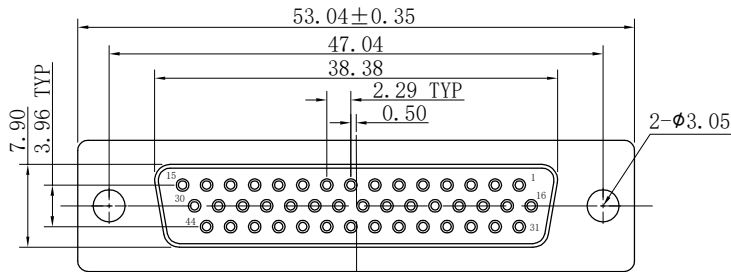


The product using material and processing must conform to the "WI-PZ-142"HSF technical standard control requirements

RoHS



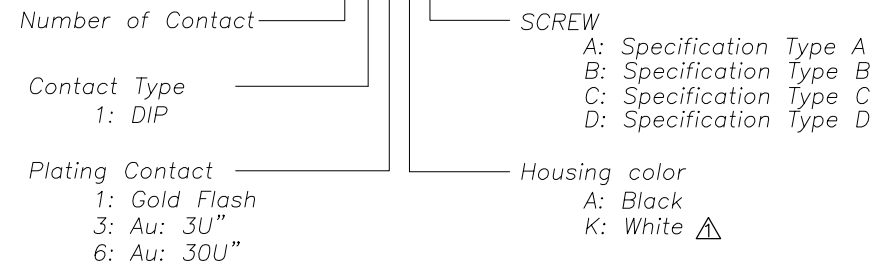
PCB layout

NOTE

- 1.MATERIAL:
 - 1.1 INSULATOR: PBT BLACK UL94V-0
 - 1.2 TERMINAL: COPPER ALLOY BRASS
GOLD FLASH ON CONTACT AREA AND TIN ON SOLDER TAIL; NICKEL ON THE BASE
 - 1.3 SHELL: STAINLESS STEEL(SUS201)
NICKEL UNDER PLATED OVER ALL
 - 1.4 BOARD LOCK: COPPER ALLOY
TIN UNDER PLATED OVER ALL
 - 1.5 SCREW: COPPER ALLOY
NICKEL UNDER PLATED OVER ALL
- 2.ELECTRICAL:
 - 2.1 INSULATOR RESISTANCE: 1000MEGOHMS MIN AT 500V DC.
 - 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC R.M.S
 - 2.3 VOLTAGE TATING: 40V AC (RMS) CONTINUOUS MAX.
 - 2.4 CURRENT RATING: 3A.
 - 2.5 CONTGACT RESISTANCE: 30 MILLIOHMS MAX.
- 3.MECHANICAL
 - 3.1 INSERTION/EXTRACTION FORCE PER CONTACT: 9.08Kgf Max
0.78Kgf Min.
- 4.ENVIRONMENTAL
 - TEMPERATURE RANGE:-55°C TO + 105°C.
- 5.SALT:48H
- 6.PACK:TRAY

ORDER INFORMTION

P/N: WLDBF0-441XXX055



Specification Type			
A	B	C	D

REV.	REVISION RECORD	DATE	UNIT	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	TITLE:	REV: A2	SHEET: 1/1
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	1:1							
A1	ADD MATERIAL/SALT/PACK	23.12.04	mm	0.0±0.35	X°REF±6°	APPROVED	Wang_jr	23.12.26	WLDBF0-441XXX055	ENDE05	HDP 44F DIP	A2	1/1
A1	Nature Cha Winte	23.12.04		0.00±0.25	X°±3°	DESIGNER	Ding_bo	23.12.26					
A2	ADD SCREW VIEW	23.12.26		0.000±0.10	X°X' ±2°	DRAWN	Ou_jian	23.12.26					

